PCN Number:	20220314005.1A				P	CN Date:	June 08, 2022		
Title: Qualification of a new Lead finish for select devices									
Customer Conta	ct: PCN /	<u>Manager</u>	Dept:	Quality Services					
		7 2022 Sam		requests July		y 08, 2022*			
*Sample reques	ts receive	d after	July 8, 20	22 will not be su					
Change Type:									
Assembly Site			Design			Wafer Bump Site			
Assembly Process			Data Sheet			Wafer Bump Material			
Assembly Materials			Part number change			Wafer Bump Process			
Mechanical S			Test Si			Wafer Fa			
Packing/Shipping/Labeling			Test Process			Wafer Fab Materials			
							Wafer Fab Process		
			PCN	Details					
Description of C	nange:								
original PCN notification. This new device is highlighted and bolded in the device list below. The expected first shipment date will be 90 days from this notice (Sept 08, 2022) for the newly added device only. The proposed 1 st ship date of June 17, 2022 still applies for the original set of devices. This PCN is to inform of an alternate lead finish qualification for the devices in the product affected section as follows:									
v	/hat		Current			New			
Lead	l finish			NiPdAu		Matte Sn			
in a single <u>standa</u> and NiPdAu. Example: – Cus Pac	tomer orde k Quantity can satisfy I. II. III.	r for 75 per Ree the abc 3 Reels 3 Reels 2 Reels	For examp 500 units of el). ove order in of NiPdAu of Matte Si of Matte Si		<mark>R –</mark> ca th 250 g way Au fin	an ship wi 00 units S ⁄s. iish.	ith both Matte Sn		
Reason for Char	ge:								
Continuity of supply									
Anticipated imp	act on For	m, Fit,	Function,	Quality or Reliabi	lity (positive	/ negative):		
None									
Impact on Envir	onmental	Rating	S						
				ental ratings followings to the associated	-	•	-		

RoHS	REACH	Green Status	IEC 62474	
🛛 No Change	🛛 No Change	🛛 No Change	🛛 No Change	
Changes to product i	dentification resulting	from this PCN:		
None				
Product Affected:				
PQ25620RYKR	PTPS25974LRPWR	TPS259461ARPWR	XPS62867RQYR	
PQ25620RYKT	PTPS259810ARPWR	TPS259470LRPWR	XPS628691CRQYR	
PQ25628RYKT	PTPS25985Z2RQPT	TPS25970ARPWR	XSD93501ERPRT	
PQ25629RYKT	PTPS51384RJNR	TPS25970LRPWR	XSD93501RPRR	
PQ25672RQMR	PTPS51386RJNR	TPS25972ARPWR	XSD93501RPRT	
PQ25792HRLRQMR	PTPS5436DCRPYR	TPS25972LRPWR	XSD93501RXHT	
PQ25792HRLRQMT	PTPS5436TCRPYR	TPS25974ARPWR	XSN2008029RWZR	
PQ25792HRRQMR	PTPS55288RPMT	TPS25974LRPWR	XSN2008030RWZR	
PQ25792HRRQMT	SN2001075RWZR	TPS53830RWZR	XTPS53830RWZT	
PQ25792RQMR	SN2001075RWZT	TPS53830RWZT	XTPS53832RWZT	
PQ25796RQMR	SN2001076RWZR	TPS53832RWZR	XTPS55289RYQR	
PQ25796RQMT	SN2001076RWZT	TPS53832RWZT	XTPS61376RYHR	
PQ25798RQMR	SN548A28RWWR	TPS62824DMQR		
PTPS22998RYZR	TAS2763RPPT	XPS61376SRYHR		
PTPS25972ARPWR	TPS22998RYZR	XPS628660ARQYR		



TI Information tive Disclosure

Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TP\$53831RWZR	Qual Device: TPS543620RPYR	Qual Device: TPS62903RPJR	QBS Package Reference: <u>SN62825DMQR</u>	QBS Package Reference: <u>TPS62085RLTR</u>
AC	Autoclave 121C	96 Hours	3/231/0	-	3/231/0	-	3/231/0
CDM	ESD - CDM	1500V	-	-	-	2/6/0	-
HAST	Biased HAST, 130C/85%RH	96 Hours	2/154/0	-	-	3/231/0	3/231/0
HBM	ESD - HBM	3000V	-	-	-	1/3/0	-
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	-	3/2310
HTSL	High Temp Storage Bake 170C	420 Hours	3/231/0	3/231/0	3/231/0	3/231/0	-
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	Pass	Pass	Pass	Pass	Pass
MSL	Thermal Integrity Sequence	Level 2-260C	3/36/0	3/36/0	3/36/0	-	3/36/0
PD	Physical Dimensions	(per mechanical drawing)	3/15/0	3/15/0	3/15/0	-	3/15/0
SD	Solderability	Pb Free	3/66/0	3/66/0	3/66/0	2/44/0	3/66/0
TC	Temperature Cycle, -55/125C	700 Cycles	3/231/0	3/231/0	-	-	3/231/0
TC	Temperature Cycle, -65/150C	500 Cycles	-	-	3/231/0	3/231/0	-
UHAST	Unbiased HAST 130C/85%RH	96 Hours	-	3/231/0	-	3/231/0	-
VM	Visual Quality Reliability Inspection	Post Temp Cycle	3/6/0	3/6/0	3/6/0	-	3/6/0

- QBS: Qual By Similarity

- QBS: Qual By Similarity - Qual Device TPS53831RWZR, TPS543620RPYR, TPS62903RPJR are qualified at LEVEL2-260C - Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable - The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours - The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours - The following are equivalent TTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours - The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/ Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

TI Qualification ID: 20210118-137850

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW Change Management Team	PCN ww admin team@list.ti.com

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